

## 2025 NSTC Workforce Awards Program Submission Intent Form (VIEW ONLY)

Last Updated: 6/11/2025

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### Page: Eligibility

**Have you secured the permission of the lead applicant organization from appropriately authorized parties to submit this application on their behalf? \***

*Select one option*

- ☐ Yes  
☐ No

**Name of Authorized Party \***

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**Job Title of Authorized Party \***

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**Does the applicant organization have a U.S. presence? \***

*Select one option*

- ☐ Yes  
☐ No

**Lead Applicant Organization Unique Entity Identifier (UEI) \***

*Applicants must provide their UEI (formerly DUNS) number at the time of submission. For applicants who have not previously received a DUNS/UEI, applicants are asked to register with [Sam.gov](https://sam.gov) to request a UEI number. Applicants must be able to demonstrate they have completed the initial registration process to secure a UEI.*

*Select one option*

- ☐ Yes, we have a UEI number.
- ☐ No, we do NOT have a UEI number, but we have completed the initial registration process to obtain a UEI number.
- ☐ No, we do NOT have a UEI number and we have NOT completed the initial registration process.

**Provide UEI number \***

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**Does the proposed project specifically support individuals pursuing semiconductor industry related education? \***

*Select one option*

- ☐ Yes
- ☐ No

**Proposals must incorporate a strategy to leverage additional funding. Is at least 10% of the expected project costs in this proposal covered by an external source or the lead applicant organization? \***

*Select one option*

- ☐ Yes
- ☐ No

## **Page: NSTC Membership**

*While entities are NOT required to be NSTC Members at the time of proposal submission, all awardees and subawardees who are not NSTC Members will be required to undergo vetting per the NSTC Membership process and enter into an NSTC Membership agreement prior to execution of an award agreement.*

*Additional information regarding NSTC Membership eligibility and the process of becoming an NSTC Member is available at [natcast.org/nstcmembership](https://natcast.org/nstcmembership).*

**Is the lead applicant organization an NSTC Member? \***

*Select one option*

- ☐ Yes
- ☐ No

**Does the lead applicant organization attest to become an NSTC Member by the time of award agreement execution? \***

*Select one option*

- ☐ Yes  
☐ No

**Page: Lead Applicant Organization**

**Organization Legal Name \***

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**Organization Name (if different)**

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**Employer/Taxpayer Identification Number (EIN/TIN) \***

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**Organization Address \***

**Street:**

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**Line2:**

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**Line3:**

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**City:**

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**Country Code:**

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**State:**

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**Zip:**

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**Organization Type \***

*Select all that apply.*

*Select one or more options*

- ☐ Community college
- ☐ U.S. accredited institution of higher education
- ☐ U.S. K-12 educational institution
- ☐ U.S. for-profit organization
- ☐ U.S. non-profit organization
- ☐ U.S. semiconductor manufacturing company
- ☐ U.S. semiconductor design company
- ☐ U.S. semiconductor research company
- ☐ U.S. technology consortium, trade association or industry association
- ☐ Federally funded research and development center (FFRDC)
- ☐ Foreign entity
- ☐ Foreign organization
- ☐ Military services training institution
- ☐ Organized labor or union organization
- ☐ Other semiconductor-related company
- ☐ Private college
- ☐ Private university
- ☐ Technical college
- ☐ Training provider
- ☐ U.S. federal government entity
- ☐ U.S. Indian tribal government entity
- ☐ U.S. local or municipal government entity
- ☐ U.S. state, local, territorial, or Indian tribal government entity
- ☐ U.S. territory government entity
- ☐ Other

**Please specify organization type not listed above. \***

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**Organization Website \***

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**Page: Authorized Representative**

*The individual to contact regarding this application.*

**Prefix \***

Select one option

- ☐ Ms.
- ☐ Miss
- ☐ Mrs.
- ☐ Mr.
- ☐ Mx.
- ☐ Rev.
- ☐ Dr.
- ☐ Prof.
- ☐ Hon.
- ☐ Not listed

**Please specify prefix not listed above. \***

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**First Name \***

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**Middle Name**

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**Last Name \***

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**Suffix**

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**Job Title \***

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**Department/Division Name**

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**Organization Name \***

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**Email Address \***

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**Phone \***

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**Page: Proposal Overview**

**Proposed Award Amount \***

*Amount must be between \$500,000 to \$2,000,000.*

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**Project Title \***

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**Performance Period Start Date \***

*Applicants must specify a performance period between one to two years, starting between March 1 and May 31, 2026.*

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**Performance Period End Date \***

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**Project Summary \***

*Please provide a brief project summary. Include a description of the project's activities and how this project improves training and access to jobs or skills in semiconductor research, manufacturing, design, and/or production. Applicants should draft this summary in a manner that can be shared in public announcements, if awarded.*

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**Geographic Areas Affected by the Project \***

*Please describe where this proposed project will be implemented and/or which geographic areas will be affected by the project (e.g., municipalities, counties, states, etc.).*

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**Target Workforce Segment \***

*Select all that apply.*

Select one or more options

- ☐ Technicians
- ☐ Engineers
- ☐ Researchers
- ☐ Administrative Roles
- ☐ Data Scientist
- ☐ Other

**Program Activities \***

*Select all that apply.*

*Select one or more options*

- ☐ Create new curriculum
- ☐ Develop existing curriculum
- ☐ Support paid work-based learning, including registered apprenticeship and pre-apprenticeship programs
- ☐ Issue industry-recognized credentials
- ☐ Develop credential standards
- ☐ Confer semiconductor industry-relevant degrees or support related coursework, such as undergraduate or graduate programs or coursework in computer engineering, electrical engineering, technology, informatics, computer programming, chemical engineering, or industrial engineering, offered by two- or four-year colleges or universities
- ☐ On-the-job training
- ☐ Mentorship
- ☐ Wage gains for demonstrated skills milestones
- ☐ Wraparound supports that reduce barriers to entry in program participation (e.g. childcare or transportation)
- ☐ Experiential learning opportunities such as worker cooperatives, externships, internships, fellowships, or capstone projects
- ☐ Recruitment effort
- ☐ Public awareness campaign
- ☐ K-12 program

**Program Maturity Level \***

*Select one.*

<b>Maturity Level</b>	<b>Description</b>
<b>Novel Innovator or Designer</b>	A new program design, concept, or limited pilot. Program lacks significant history, if any, but shows promising signs of benefit based on stakeholder input, regional conditions, or other criteria.
<b>Early Market Incubator or Developer</b>	Existing program that operates on a small scale such as a single employer and single training provider with a small number of participants per year. The program has limited history, but some evidence of



	stakeholder engagement including employers and participants.
<b>Late Market Leader and Implementor</b>	Existing program that operates at a moderate level of impact. Program has a few years of history, a selection or network of stakeholders, and a track record of participant completions.
<b>Market Leader or Accelerator</b>	Program has a high degree of past success. Program likely has existing stakeholder network such as major employer investment, strong advisory board, formalized agreements, and significant track record of participant completion and job placement.

*Select one option*

- ☐ Novel Innovator of Designer
- ☐ Early Market Incubator or Developer
- ☐ Late Market Leader and Implementor
- ☐ Market Leader or Accelerator

**Does this project involve subawardees? \***

*For the purposes of this section, a subawardee is an entity that carries out a defined, substantive portion of the programmatic work. For example, a subawardee may help design the program execution framework, determine eligibility of program participants, or develop publishable results in relation to the program. Subawardee personnel may be included as PI/PD, Co-PI or key personnel on the award, and performance is measured against whether the award objectives are met. A subawardee has responsibility for adherence to applicable Federal program compliance requirements.*

*Select one option*

- ☐ Yes
- ☐ No

**Subawardees \***

*Using the table below, add the name of each subawardee organization involved. You must add a minimum of one and may add a maximum of ten.*

## Subawardees

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## Ecosystem Partners \*

*Select the options below that best describe the types of entities that will be active partners in this project.*

*Select all that apply.*

Select one or more options

- ☐ Career/Technical Education provider(s)
- ☐ Community Based Organizations
- ☐ Community College(s)
- ☐ Economic Development
- ☐ Employer(s)
- ☐ Higher Education
- ☐ K-12 Education
- ☐ Labor Organization(s)
- ☐ Non-profit(s)
- ☐ Sector Partnership Organization(s)
- ☐ State and/or Local Government
- ☐ State and/or Local Workforce Development Board(s)
- ☐ Regional Workforce Intermediaries
- ☐ Other

**Please specify other ecosystem partner(s) not listed above. \***

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## Leveraged Funding Strategy \*

*Proposals must incorporate a strategy to leverage 10% of the total funding from external stakeholders or the applicant organization. Please provide a brief description of the leveraged funding strategy.*

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## Page: Project Design

### Project Design \*

*Describe the project, including its theory of change. Your theory of change should describe relevant inputs, outputs, and short-, medium-, and long-term outcomes. Include the type of project or design and its attributes, such as recruitment strategies, program duration, skills to be acquired, credentials awarded and whether they are stackable and aligned with a career pathway. Include any prior successes using these methods, describe the outcomes and lessons learned, and explain how goals will be met. Include evidence-based strategies, partners and stakeholders, and maturity of project and partnerships.*

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**Indicate the ways in which this award will directly enable project implementation and/or scaling and expansion. \***

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## Page: Anticipated Outcomes

*Please enter your anticipated outcomes for the project.*

**Total number of participants recruited \***

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**Total number enrolled in the program \***

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**Total number of participants completing the program \***

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**Total number of program completers to enter the semiconductor industry \***

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### **Page: Employer Letter**

*Please upload at least one Letter of Support or Commitment from a private sector semiconductor industry employer. If the lead applicant is an employer, please outline your commitments in writing following the guidelines below.*

*For the purposes of this section, a semiconductor industry employer is defined as a private sector company that is directly involved in the design, manufacturing, or production of microelectronics or equipment used to produce microelectronic components. It does NOT include other members of the semiconductor workforce ecosystem, such as training providers, academic institutions, consulting firms, non-profit organizations, or investment firms.*

*In the review of full proposals, preference will be given to letters from NSTC members in good standing. A full list of current NSTC members is available at [natcast.org/nstcmembership/members](https://natcast.org/nstcmembership/members).*

**Letters must:**

- 1. Provide a description of the proposed relationship between the applicant and employer as it relates to the execution of the proposed project.*
- 2. Address any numerical training/interview/hiring commitments from the employer.*
- 3. Provide a description of how successful implementation of this project would positively affect the employer's workforce.*
- 4. Address any committed funding support.*
- 5. Be signed by an individual with authority to legally bind the organization to its commitment.*

**Employer Letter Upload \***

Combine all letters into one PDF. Each letter must not exceed one page.

**Accepted file types:** pdf

File may not exceed 5 MB in size.

[File Upload]

**Employer Letter Information \***

*Provide the following information for each uploaded letter.*

Letter Details

**Organization Name \***

**Signer Full Name \***

**Signer Job Title \***

**Page: Acknowledgement of Terms**

**Acknowledgement of Terms \***

1. You have read the full Call for Proposals (CFP) solicitation associated with this application, understand, and consent to the terms listed therein.
2. The lead applicant has a U.S. presence.
3. The lead applicant is not a foreign entity of concern or foreign country of concern, as those terms are defined in 15 C.F.R. 231.104 and 231.102, respectively.
4. The lead applicant and subawardees proposed in this program are not banned from doing business with the U.S. government. They are not debarred, suspended, or otherwise excluded from receiving an award by the Federal Government or otherwise

prohibited by Presidential Executive Order or law from receiving an award from the Federal Government as listed in Sam.gov.

5. No Federal appropriated funds have been paid or will be paid to any person for influencing or attempting to influence an officer or employee of any agency, a Member of congress, an office, or employee of Congress, or an employee of a Member of Congress on the lead applicant's or subawardee's behalf in connection with the making of an award under this CFP.
6. Awards will be required to undergo vetting per the NSTC membership process and enter into a membership agreement with NSTC at the time of award.
7. No funds proposed in this application will be used for construction costs, profits, product development, commercialization, or the acquisition or lease of real property.
8. This application may be shared with Federal agencies and any parts of a proposal shared with Federal agencies may be subject to requests under The Freedom of Information Act (5 U.S.C. § 552).

By signing this Submission Intent Form, I represent and warrant that the statements herein are true, complete and accurate to the best of my knowledge. I also provide the above assurances; and agree to comply with any resulting terms if I accept an award. I am aware that any false statements or misrepresentations may result in the rejection of the application or the termination of any grant awarded.

Select one or more options

☐ I Agree